Laad-fres Oreen

## 450V P-CHANNEL ENHANCEMENT MODE MOSFET

## Product Summary

| BV $_{\text {DSS }}$ | $\mathbf{R}_{\text {DS(ON })}$ | $\mathbf{I D}_{\mathbf{D}}$ <br> $\mathbf{T}_{\mathbf{A}}=+\mathbf{+ 2 5 ^ { \circ }} \mathbf{C}$ |
| :---: | :---: | :---: |
| -450 V | $150 \Omega @ \mathrm{~V}_{\mathrm{GS}}=-10 \mathrm{~V}$ | -0.25 A |

## Description

This 450V enhancement mode P-channel MOSFET provides users with a competitive specification offering efficient power handling capability, high impedance and is free from thermal runaway and thermally induced secondary breakdown. Applications benefiting from this device include a variety of Telecom and general high voltage switching circuits.

## Applications

## - Load Switching

- Uninterrupted Power Supply


## Features and Benefits

- Low Gate Drive
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)


## Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe.

Solderable per MIL-STD-202, Method 208 ③

- Weight: 0.112 grams (Approximate)



## Ordering Information (Note 4)

| Part Number | Qualification | Case | Packaging |
| :---: | :---: | :---: | :---: |
| DMP45H150DHE-13 | Standard | SOT223 | $2,500 /$ Tape \& Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) \& 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## Marking Information



Jii = Manufacturer's Marking
P450H2 = Marking Code
YWW $=$ Date Code Marking
$Y$ or $\bar{Y}=$ Year (ex: $7=2017$ )
WW = Week (01 to 53)

DMP45H150DHE

Maximum Ratings (@T $\mathrm{A}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Drain-Source Voltage |  | $V_{\text {DSS }}$ | -450 | V |
| Gate-Source Voltage |  | $\mathrm{V}_{\text {GSS }}$ | $\pm 30$ | V |
| Continuous Drain Current (Note 5) V ${ }_{\text {GS }}=-10 \mathrm{~V}$ | $\begin{aligned} & \hline \mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{C}}=+70^{\circ} \mathrm{C} \end{aligned}$ | ID | $\begin{aligned} & \hline-0.25 \\ & -0.20 \end{aligned}$ | A |
| Pulsed Drain Current (10 $\mu$ s Pulse, Duty Cycle = 1\%) |  | IDM | -0.45 | A |
| Maximum Body Diode Continuous Current |  | Is | -0.45 | A |
| Avalanche Energy (Note 6) L=60mH |  | $\mathrm{E}_{\text {AS }}$ | 4 | mJ |
| Avalanche Current (Note 6) L=60mH |  | $\mathrm{I}_{\text {AS }}$ | 0.25 | A |
| Peak Diode Recovery dv/dt ( $\mathrm{I}_{\text {SD }} \leq 1.0 \mathrm{~A}, \mathrm{di} / \mathrm{dt} \leq 100 \mathrm{~A} / \mu \mathrm{s}$ ) |  | dv/dt | 4.5 | $\mathrm{V} / \mathrm{ns}$ |

Thermal Characteristics $\left(@ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise specified.)

| Characteristic |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Total Power Dissipation (Note 6) | $\mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}$ | PD | 13.9 | W |
|  | $\mathrm{T}_{\mathrm{C}}=+70^{\circ} \mathrm{C}$ |  | 8.9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction to Ambient | (Note 6) | $\mathrm{R}_{\text {өJA }}$ | 59.4 | W |
| Thermal Resistance, Junction to Case | (Note 6) | $\mathrm{R}_{\text {өJc }}$ | 8.9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {STG }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics ( $@ T_{A}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 5) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | -450 | - | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current | IDSS | - | - | -1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=-450 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |
| Gate-Source Leakage | IGSS | - | - | $\pm 100$ | nA | $\mathrm{V}_{\mathrm{GS}}= \pm 30 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 5) |  |  |  |  |  |  |
| Gate Threshold Voltage | V GS(TH) | -2.0 | -3.0 | -4.0 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | $\mathrm{R}_{\mathrm{DS} \text { (ON) }}$ | - | 40 | 150 | $\Omega$ | $V_{G S}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-50 \mathrm{~mA}$ |
| Diode Forward Voltage | $\mathrm{V}_{\text {SD }}$ | - | -0.8 | -1.2 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{IS}=-50 \mathrm{~mA}$ |
| DYNAMIC CHARACTERISTICS (Note 6) |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{Cl}_{\text {ISS }}$ | - | 59.2 | - |  |  |
| Output Capacitance | Coss | - | 11 | - | pF | $\mathrm{V}_{\mathrm{DS}}=-25 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {RSS }}$ | - | 1 | - |  |  |
| Forward Transconductance | gFs | 40 | - | - | ms | $\mathrm{V}_{\mathrm{DS}}=-25 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-50 \mathrm{~mA}$ |
| Gate Resistance | $\mathrm{R}_{\mathrm{G}}$ | - | 50 | - | $\Omega$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |
| Total Gate Charge | $\mathrm{Q}_{\mathrm{G}}$ | - | 1.8 | - |  |  |
| Gate-Source Charge | $\mathrm{Q}_{\mathrm{GS}}$ | - | 0.3 | - | nC | $V_{D S}=-225 \mathrm{~V}, I_{D}=-100 \mathrm{~mA}, V_{G S}=-$ 10V |
| Gate-Drain Charge | QGD | - | 0.9 | - |  |  |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{D} \text { (ON) }}$ | - | 12 | - |  |  |
| Turn-On Rise Time | $\mathrm{t}_{\mathrm{R}}$ | - | 9 | - | ns | $V_{D D}=-225 \mathrm{~V}, \mathrm{R}_{G}=3.00, \mathrm{I}_{\mathrm{D}}=-100 \mathrm{~mA}$ |
| Turn-Off Delay Time | to(off) | - | 19 | - |  | $V_{D D}=-225 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=3.0 \Omega, l_{\mathrm{D}}=-100 \mathrm{~mA}$ |
| Turn-Off Fall Time | $\mathrm{t}_{\mathrm{F}}$ | - | 87 | - |  |  |
| Body Diode Reverse Recovery Time | trR | - | 108 | - | ns | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{Is}=-100 \mathrm{~mA}, \mathrm{VDD}=-100 \mathrm{~V}, \\ & \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s} \end{aligned}$ |
| Body Diode Reverse Recovery Charge | QRR | - | 391 | - | nC | $\begin{aligned} & V_{G S}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-100 \mathrm{~mA}, \\ & \mathrm{VDD}=-100 \mathrm{~V}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s} \end{aligned}$ |

Notes: $\quad$. Device mounted on FR-4 substrate PC board, 2 oz copper, with 1 inch square copper pad layout.
6. Guaranteed by design. Not subject to production testing.


Figure 1.Typical Output Characteristic


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

$\mathrm{V}_{\mathrm{GS}}$, GATE-SOURCE VOLTAGE (V)
Figure 2. Typical Transfer Characteristic

$\mathrm{V}_{\mathrm{GS}}$, GATE-SOURCE VOLTAGE (V)
Figure 4. Typical Transfer Characteristic


Figure 6. On-Resistance Variation with Temperature

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$\mathrm{T}_{\mathrm{J}}$, JUNCTION TEMPERATURE $\left({ }^{\circ} \mathrm{C}\right)$
Figure 7. On-Resistance Variation with Temperature


Figure 9. Diode Forward Voltage vs. Current


$\mathrm{V}_{\mathrm{DS}}$, DRAIN-SOURCE VOLTAGE (V)
Figure 12. SOA, Safe Operation Area

## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

## SOT223



| SOT223 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A | 1.55 | 1.65 | 1.60 |
| A1 | 0.010 | 0.15 | 0.05 |
| b | 0.60 | 0.80 | 0.70 |
| b1 | 2.90 | 3.10 | 3.00 |
| C | 0.20 | 0.30 | 0.25 |
| D | 6.45 | 6.55 | 6.50 |
| E | 3.45 | 3.55 | 3.50 |
| E1 | 6.90 | 7.10 | 7.00 |
| e | - | - | 4.60 |
| e1 | - | - | 2.30 |
| L | 0.85 | 1.05 | 0.95 |
| Q | 0.84 | 0.94 | 0.89 |
| All Dimensions in $\mathbf{~ m m}$ |  |  |  |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.


| Dimensions | Value (in mm) |
| :---: | :---: |
| $\mathbf{C}$ | 2.30 |
| $\mathbf{C 1}$ | 6.40 |
| $\mathbf{X}$ | 1.20 |
| $\mathbf{X 1}$ | 3.30 |
| $\mathbf{Y}$ | 1.60 |
| $\mathbf{Y 1}$ | 1.60 |
| $\mathbf{Y 2}$ | 8.00 |

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